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(12) **United States Design Patent**
Chen

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(54) **WIRELESS EARPHONE**
(71) Applicant: **SHENZHEN SIXPIPES TECHNOLOGY CO., LTD**, Shenzhen (CN)
(72) Inventor: **Guohua Chen**, Shenzhen (CN)
(73) Assignee: **SHENZHEN SIXPIPES TECHNOLOGY CO., LTD**, Shenzhen (CN)
(**) Term: **15 Years**

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(51) **LOC (13) Cl.** **14-01**
(52) **U.S. Cl.**
USPC **D14/223**
(58) **Field of Classification Search**
USPC D14/223, 205; D24/174; 128/864, 865,
128/866; 381/380, 381, 370; 455/90.3,
455/575.1, 569.1
CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1066; H04R 1/1016; H04R
5/033; H04R 5/0335; H04R 1/105; H04R
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See application file for complete search history.

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Primary Examiner — Paula Allen Greene

(57) **CLAIM**

The ornamental design for a wireless earphone, as shown and described.

DESCRIPTION

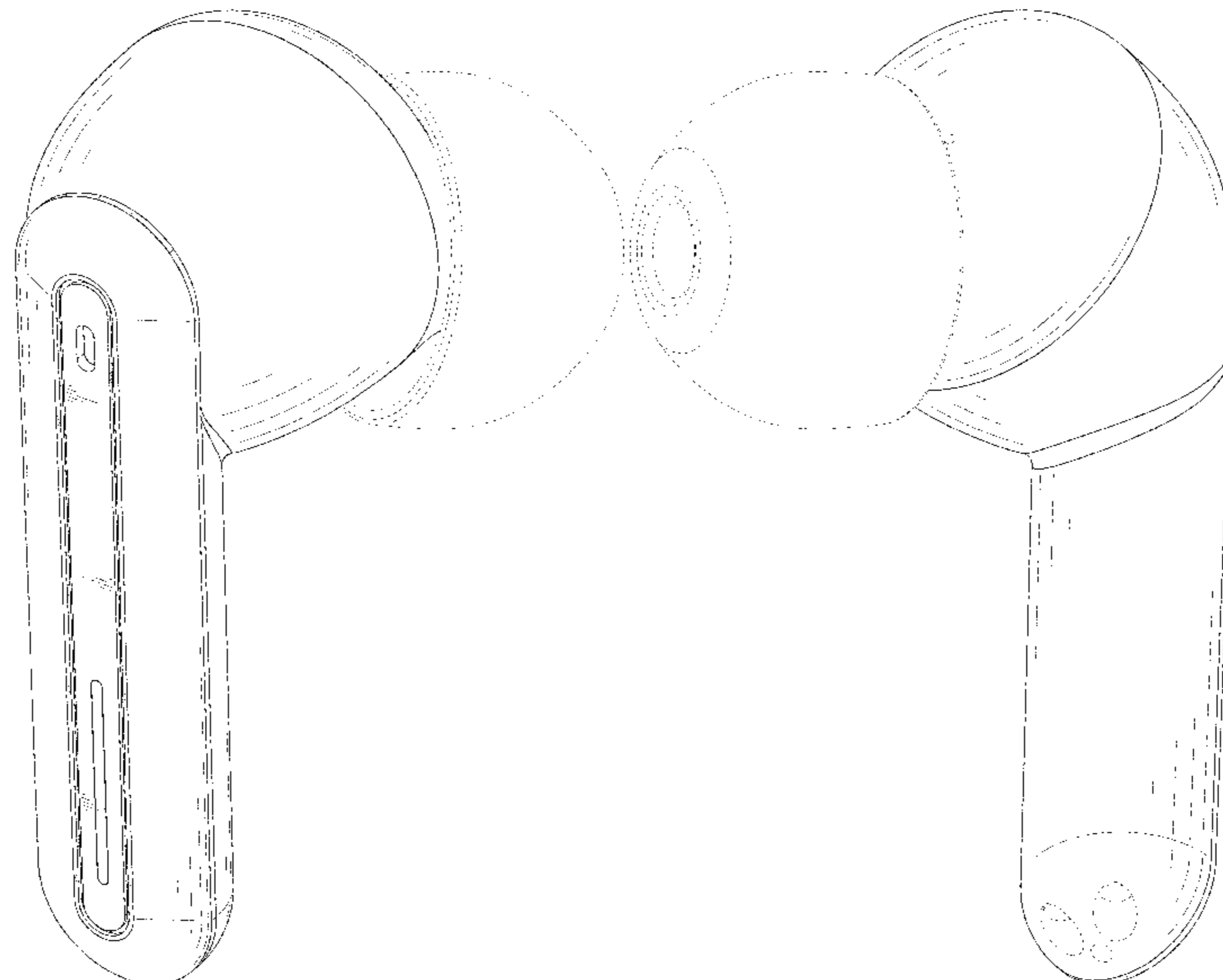
FIG. 1 is a perspective view of a wireless earphone showing my new design;
FIG. 2 is another perspective view thereof;
FIG. 3 is a front elevational view thereof
FIG. 4 is a rear elevational view thereof;
FIG. 5 is a left side elevational view thereof;
FIG. 6 is a right side elevational view thereof;
FIG. 7 is a top plan view thereof; and,
FIG. 8 is a bottom plan view thereof.
The broken lines in the drawings depict portions of the wireless earphone that form no part of the claimed design.

1 Claim, 8 Drawing Sheets

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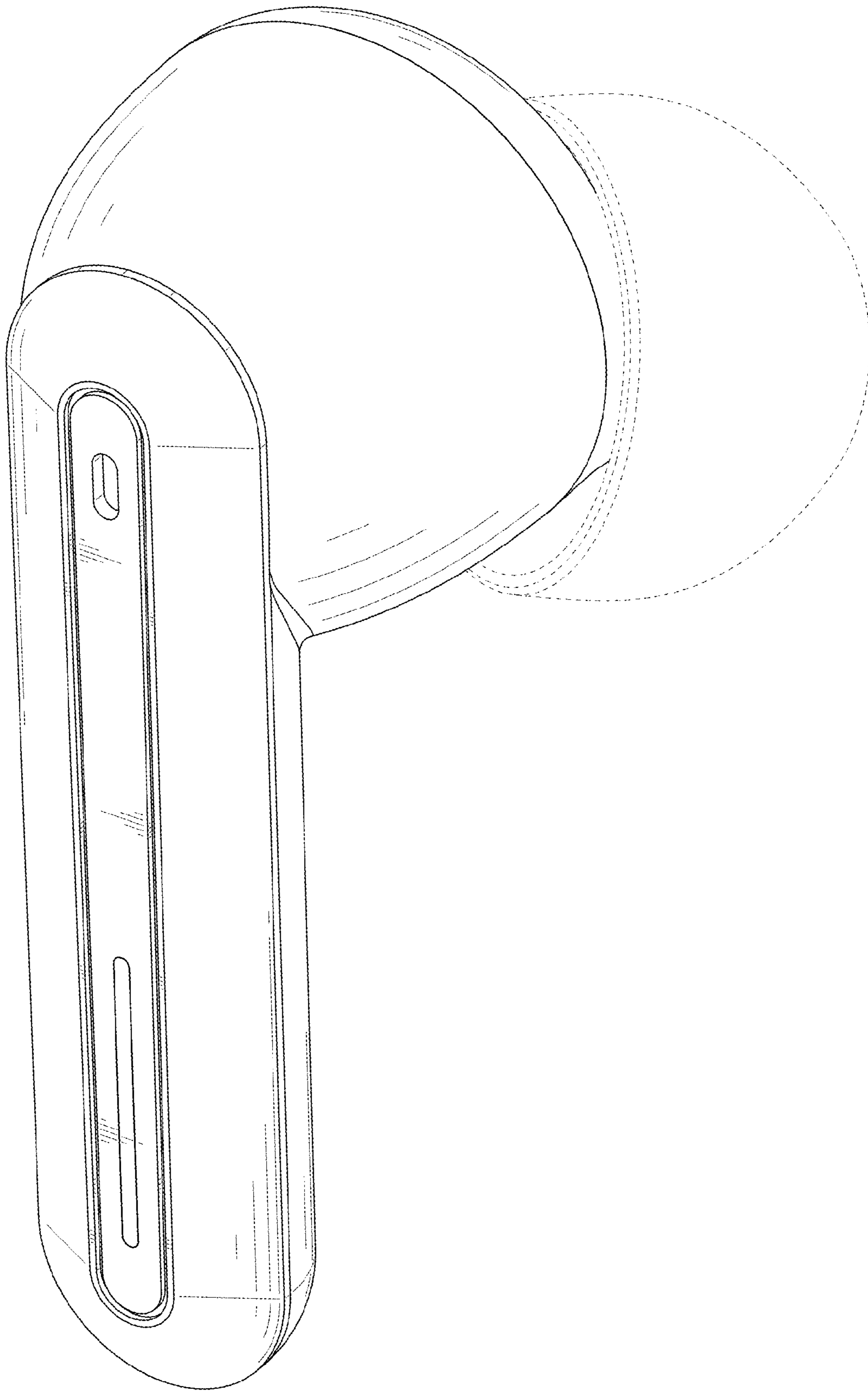


FIG. 1

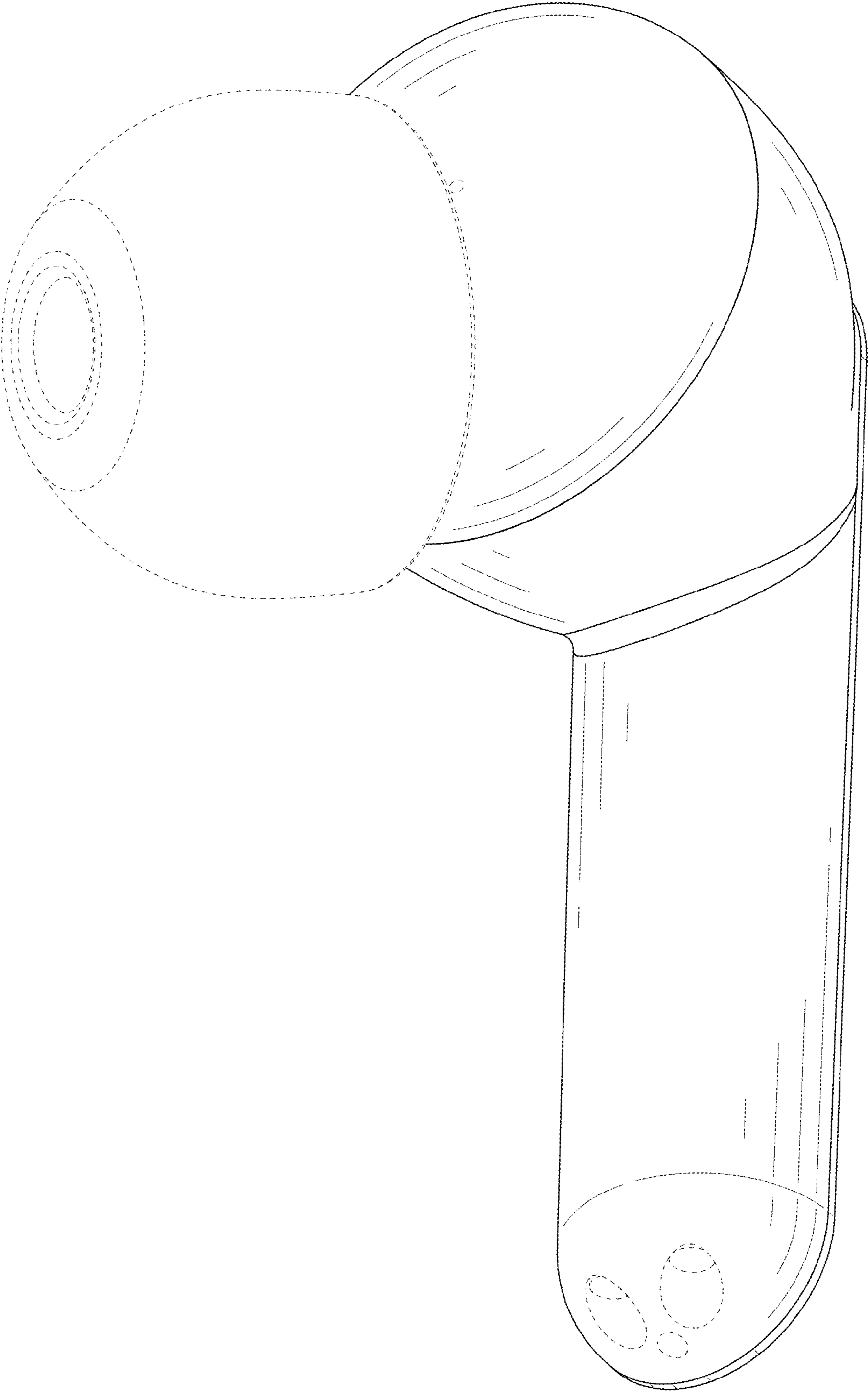


FIG. 2

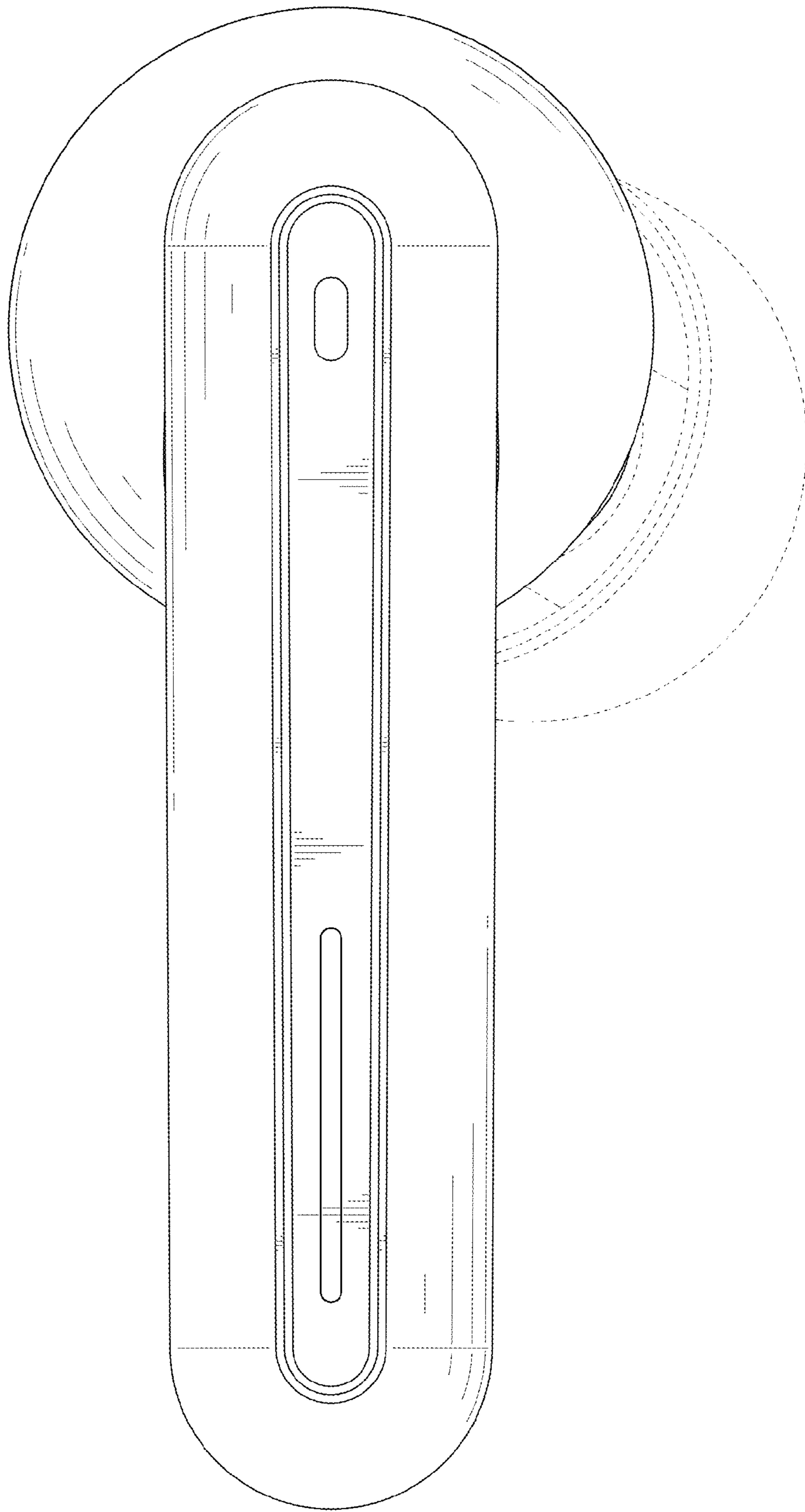


FIG. 3

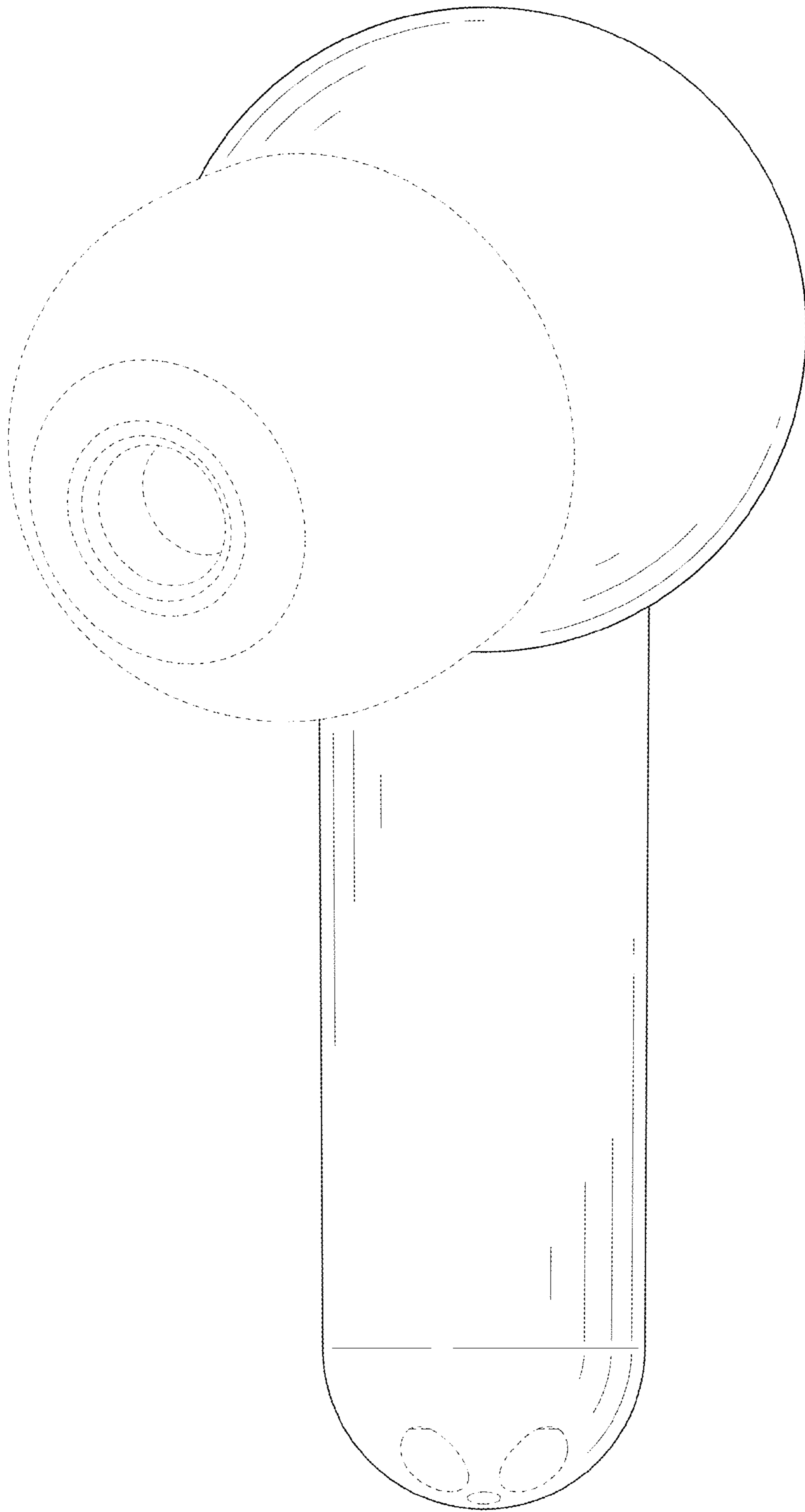


FIG. 4

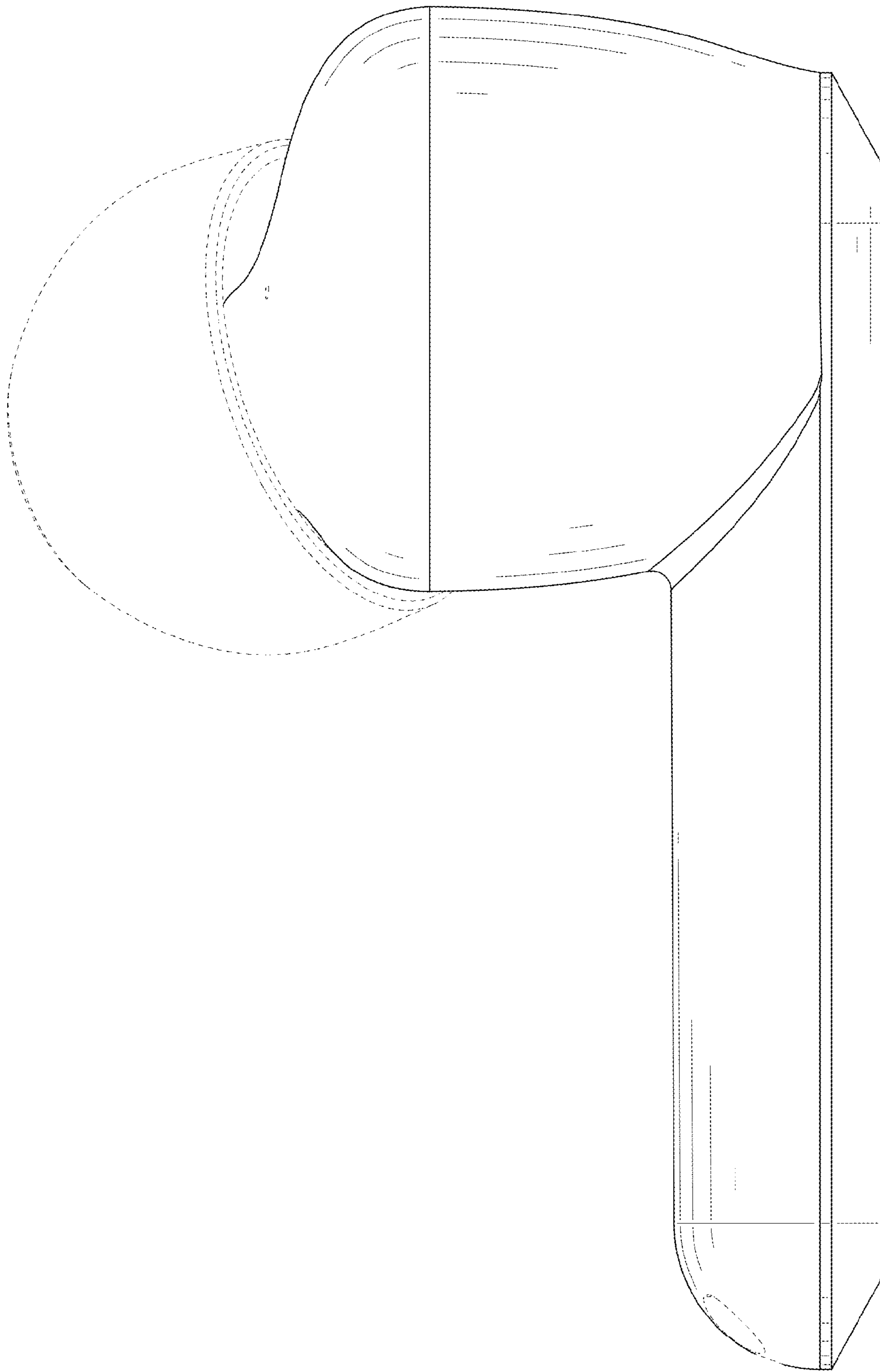


FIG. 5

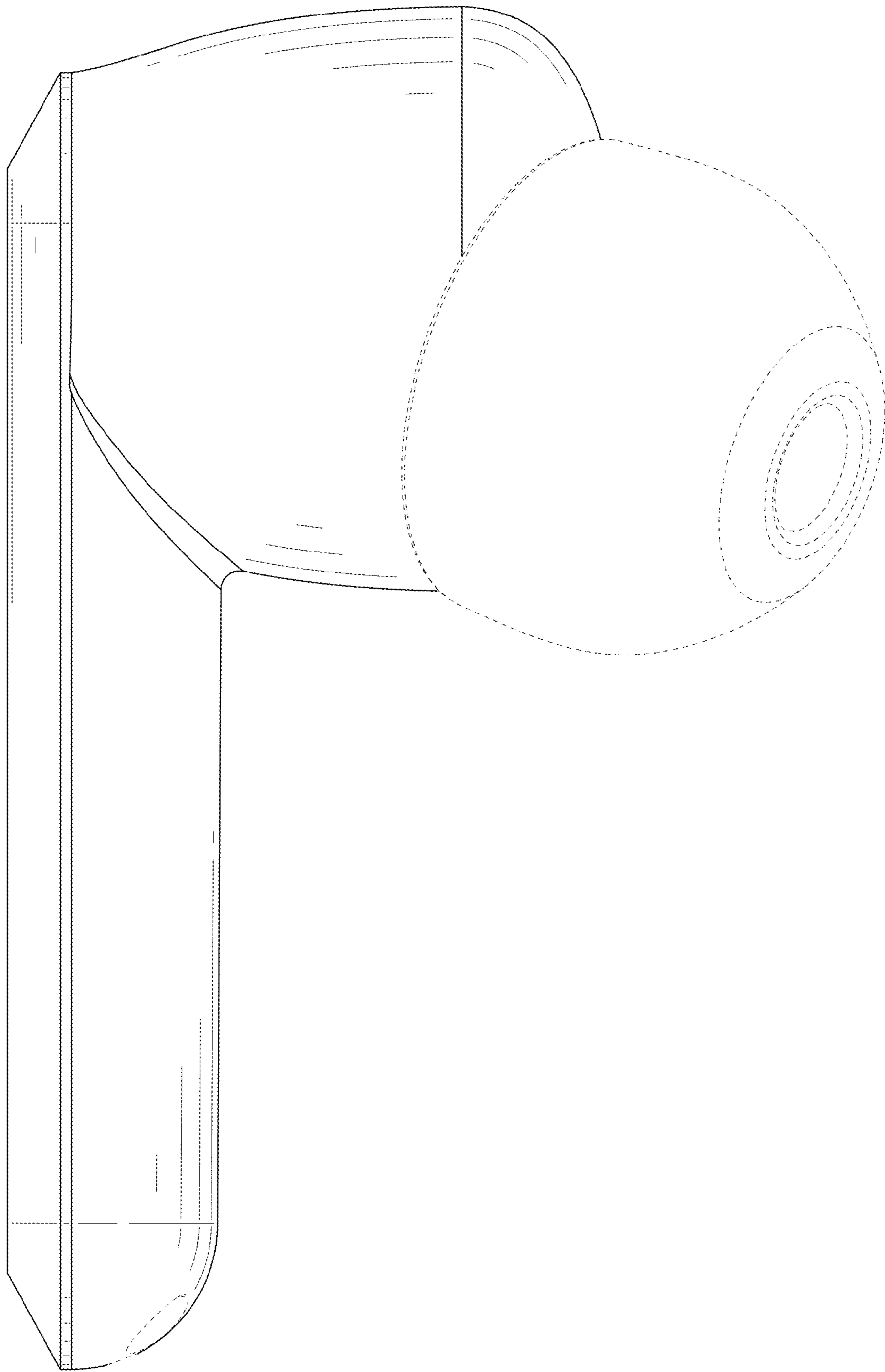


FIG. 6

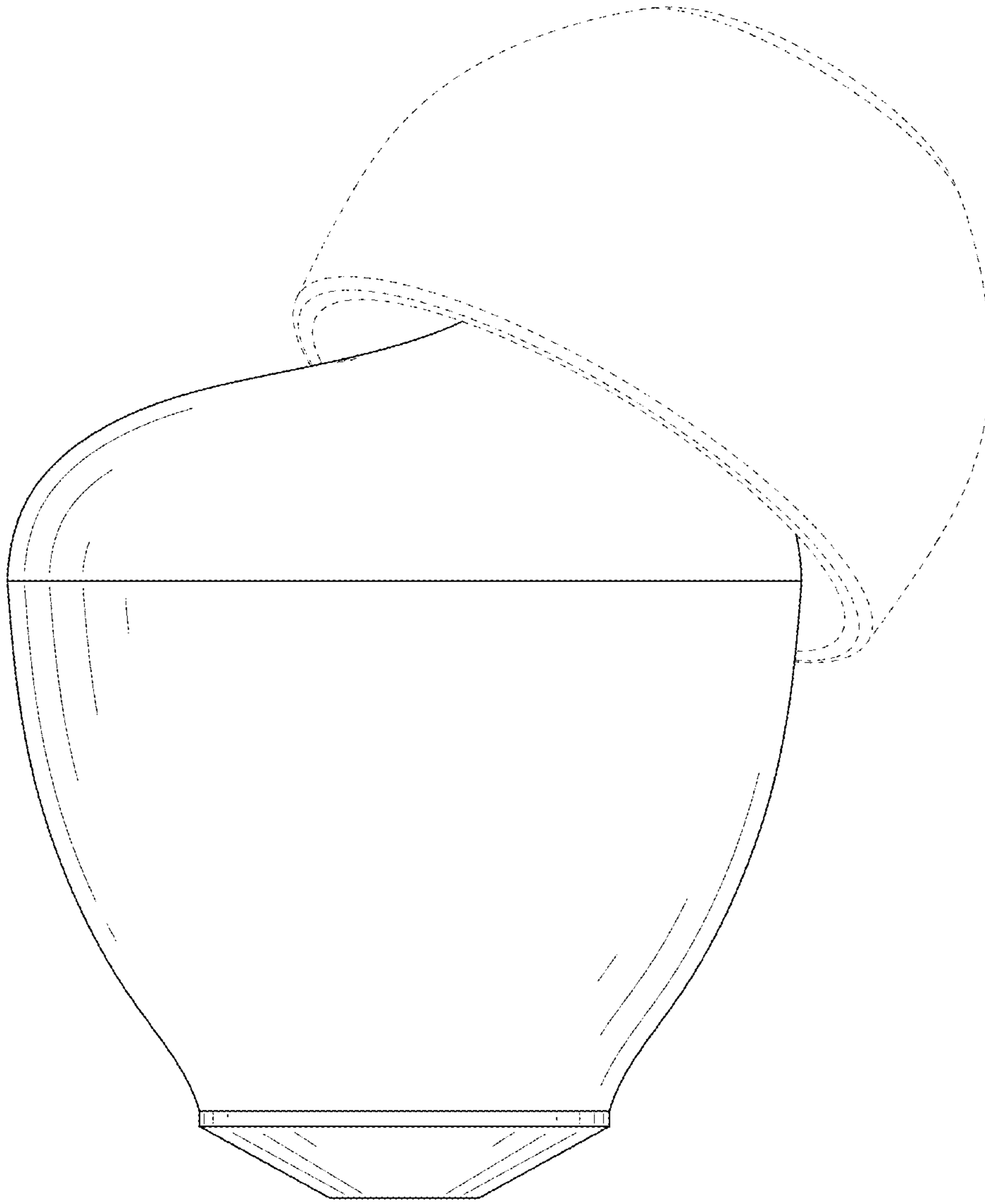


FIG. 7

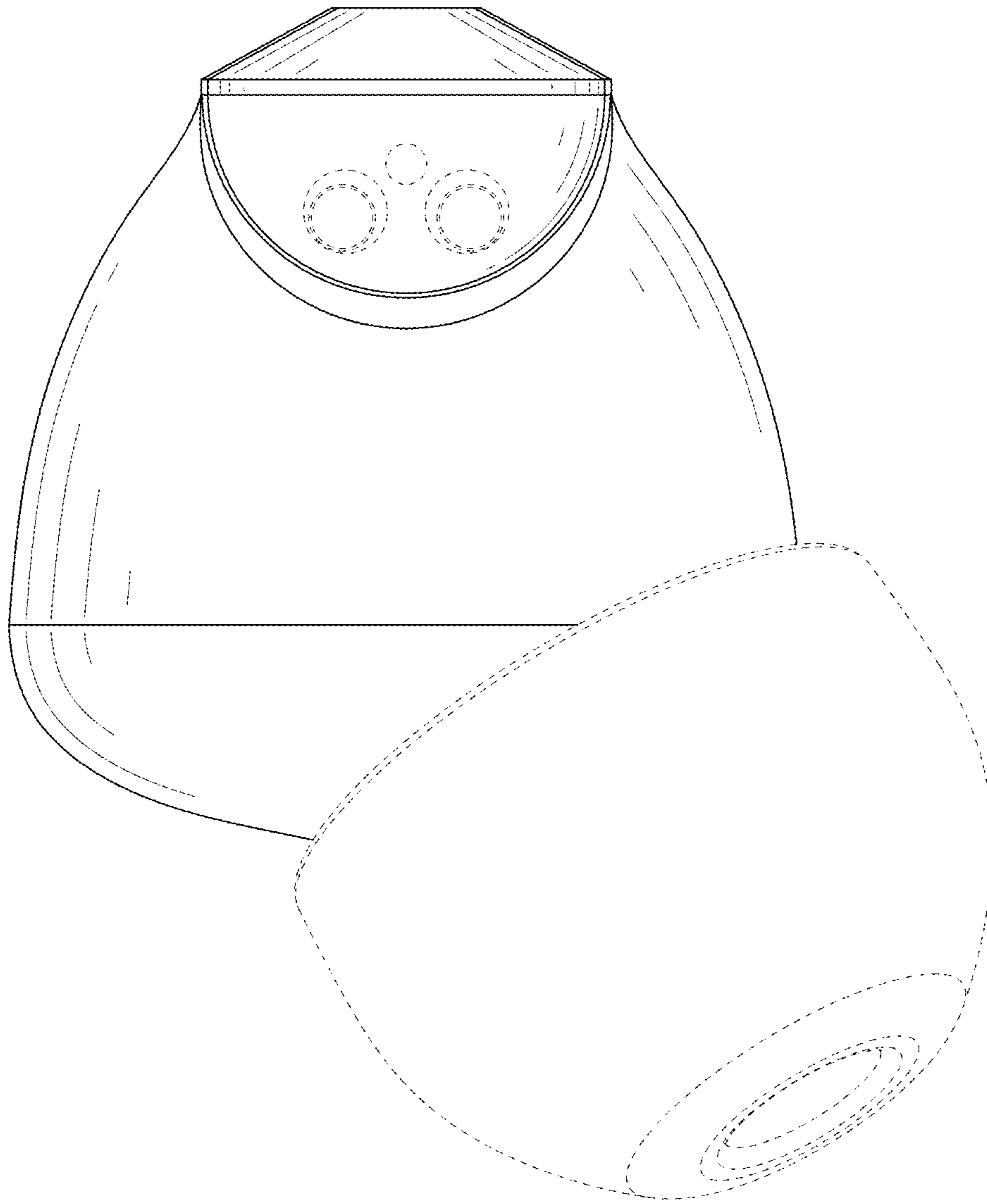


FIG. 8